

## HIGH EFFICIENCY RECTIFIERS

VOLTAGE RANGE: 100 --- 600 V  
CURRENT: 5.0 A

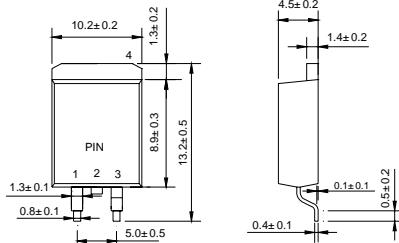
### FEATURES

- ◇ Low cost
- ◇ Low leakage
- ◇ Low forward voltage drop
- ◇ High current capability
- ◇ Easily cleaned with alcohol, Isopropanol and similar solvents
- ◇ The plastic material carries U/L recognition 94V-0

### MECHANICAL DATA

- ◇ Case: JEDEC D<sup>2</sup>PAK, molded plastic body
- ◇ Terminals: Solderable per MIL-STD-750, Method 2026
- ◇ Polarity: As marked
- ◇ Weight: 0.087 ounces, 2.2 grams
- ◇ Mounting position: Any

### D<sup>2</sup>PAK



Dimensions in millimeters

### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

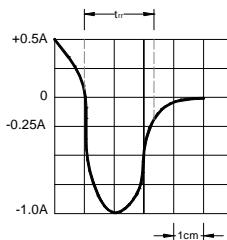
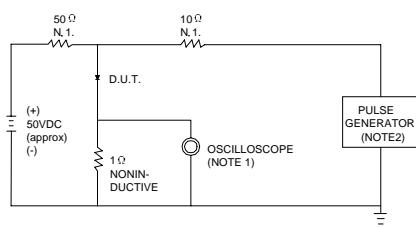
Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate by 20%.

		HER 510B	HER 520B	HER 540B	HER 560B	UNITS
Maximum recurrent peak reverse voltage	V <sub>RRM</sub>	100	200	400	600	V
Maximum RMS voltage	V <sub>RMS</sub>	70	140	280	420	V
Maximum DC blocking voltage	V <sub>DC</sub>	100	200	400	600	V
Maximum average forward rectified current 9.5mm lead length, @T <sub>c</sub> =75°C	I <sub>F(AV)</sub>	5.0				A
Peak forward surge current 8.3ms single half-sine-wave superimposed on rated load @T <sub>j</sub> =125°C	I <sub>FSM</sub>	100				A
Maximum instantaneous forward voltage @ 5.0A	V <sub>F</sub>	1.0		1.3	1.7	V
Maximum reverse current @T <sub>A</sub> =25°C at rated DC blocking voltage @T <sub>A</sub> =100°C	I <sub>R</sub>	10 150			μA	
Maximum reverse recovery time (Note1)	t <sub>rr</sub>	50		100	ns	
Typical junction capacitance (Note2)	C <sub>J</sub>	40				pF
Typical thermal resistance (Note3)	R <sub>θJC</sub>	20				°C/W
Operating junction temperature range	T <sub>J</sub>	- 55 ---- + 150				°C
Storage temperature range	T <sub>STG</sub>	- 55 ---- + 150				°C

NOTE: 1. Measured with I<sub>F</sub>=0.5A, I<sub>R</sub>=1A, I<sub>rr</sub>=0.25A.

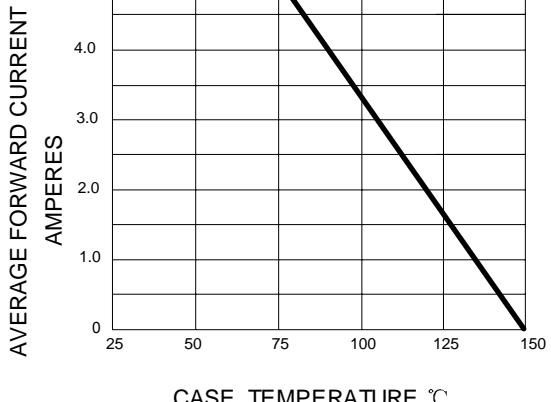
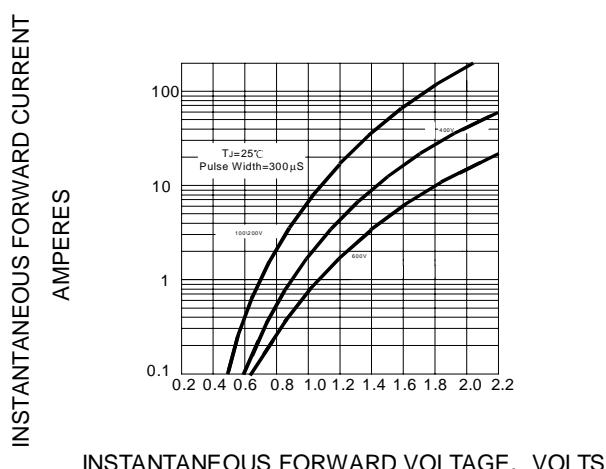
2. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.

3. Thermal resistance junction to ambient.

FIG.1 -- TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTIC

NOTES:  
1. RISE TIME = 7ns MAX.INPUT IMPEDANCE = 1M $\Omega$ .22pF.  
2. RISE TIME = 10ns MAX.SOURCE IMPEDANCE=50  $\Omega$ .

SET TIME BASE FOR 20/45 ns/cm

FIG.2 -- TYPICAL FORWARD CHARACTERISTICFIG.4 -- TYPICAL JUNCTION CAPACITANCE